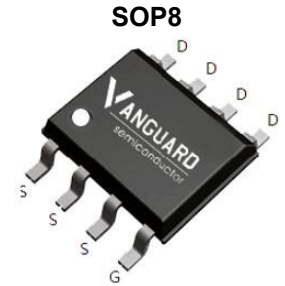


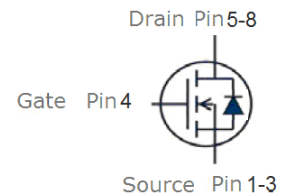
## Features

- Enhancement mode
- Low on-resistance  $R_{DS(on)}$  @  $V_{GS}=4.5\text{ V}$
- VitoMOS<sup>®</sup> II Technology
- 100% Avalanche test
- Pb-free lead plating; RoHS compliant

$V_{DS}$	60	V
$R_{DS(on),TYP}@ V_{GS}=10\text{ V}$	5.5	m $\Omega$
$R_{DS(on),TYP}@ V_{GS}=4.5\text{ V}$	8.0	m $\Omega$
$I_D$	18	A



Part ID	Package Type	Marking	Tape and reel information
VS6606GS	SOP8	6606GS	3000PCS/Reel



## Maximum ratings, at $T_A=25^\circ\text{C}$ , unless otherwise specified

Symbol	Parameter	Rating	Unit
$V_{(BR)DSS}$	Drain-Source breakdown voltage	60	V
$V_{GS}$	Gate-Source voltage	$\pm 20$	V
$I_S$	Diode continuous forward current	$T_A=25^\circ\text{C}$	2.6 A
$I_D$	Continuous drain current @ $V_{GS}=10\text{V}$	$T_A=25^\circ\text{C}$	18 A
		$T_A=70^\circ\text{C}$	15 A
$I_{DM}$	Pulse drain current tested ①	$T_A=25^\circ\text{C}$	72 A
EAS	Avalanche energy, single pulsed ②	25	mJ
$P_D$	Maximum power dissipation	$T_A=25^\circ\text{C}$	3.1 W
$T_{STG}, T_J$	Storage and junction temperature range	-55 to 150	$^\circ\text{C}$

## Thermal Characteristics

Symbol	Parameter	Typical	Unit
$R_{\theta JL}$	Thermal Resistance, Junction-to-Lead	24	$^\circ\text{C/W}$
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	40	$^\circ\text{C/W}$

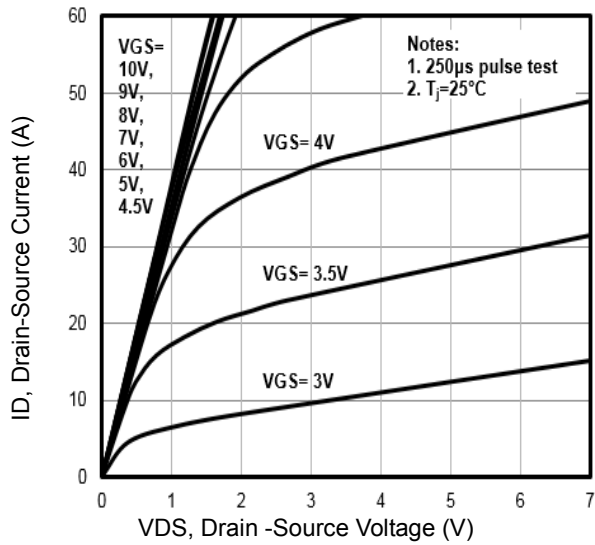
**Electrical Characteristics**

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
<b>Static Electrical Characteristics @ T<sub>j</sub>=25°C (unless otherwise stated)</b>						
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	60	--	--	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current(T <sub>j</sub> =25°C)	V <sub>DS</sub> =60V,V <sub>GS</sub> =0V	--	--	1	uA
	Zero Gate Voltage Drain Current(T <sub>j</sub> =125°C)	V <sub>DS</sub> =60V,V <sub>GS</sub> =0V	--	--	100	uA
I <sub>GSS</sub>	Gate-Body Leakage Current	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V	--	--	±100	nA
V <sub>GS(TH)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =250μA	1.4	1.8	2.5	V
R <sub>DS(ON)</sub>	Drain-Source On-State Resistance ③	V <sub>GS</sub> =10V, I <sub>D</sub> =12A	--	5.5	8	mΩ
		T <sub>j</sub> =100°C	--	7	--	mΩ
R <sub>DS(ON)</sub>	Drain-Source On-State Resistance ③	V <sub>GS</sub> =4.5V, I <sub>D</sub> =8A	--	8	11	mΩ
<b>Dynamic Electrical Characteristics @ T<sub>j</sub> = 25°C (unless otherwise stated)</b>						
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =30V,V <sub>GS</sub> =0V, f=1MHz	1645	1935	2225	pF
C <sub>oss</sub>	Output Capacitance		705	830	955	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		25	35	45	pF
R <sub>g</sub>	Gate Resistance	f=1MHz	--	1.5	--	Ω
Q <sub>g</sub> (10V)	Total Gate Charge	V <sub>DS</sub> =30V,I <sub>D</sub> =12A, V <sub>GS</sub> =10V	--	28	--	nC
Q <sub>g</sub> (4.5V)	Total Gate Charge		--	13	--	nC
Q <sub>gs</sub>	Gate-Source Charge		--	5.6	--	nC
Q <sub>gd</sub>	Gate-Drain Charge		--	3.4	--	nC
<b>Switching Characteristics</b>						
t <sub>d(on)</sub>	Turn-on Delay Time	V <sub>DD</sub> =30V, I <sub>D</sub> =12A, R <sub>G</sub> =3.0Ω, V <sub>GS</sub> =10V	--	8.4	--	ns
t <sub>r</sub>	Turn-on Rise Time		--	18	--	ns
t <sub>d(off)</sub>	Turn-Off Delay Time		--	23	--	ns
t <sub>f</sub>	Turn-Off Fall Time		--	8.4	--	ns
<b>Source- Drain Diode Characteristics@ T<sub>j</sub> = 25°C (unless otherwise stated)</b>						
V <sub>SD</sub>	Forward on voltage	I <sub>SD</sub> =12A,V <sub>GS</sub> =0V	--	0.8	1.2	V
t <sub>rr</sub>	Reverse Recovery Time	T <sub>j</sub> =25°C,I <sub>sd</sub> =12A, V <sub>GS</sub> =0V	--	36	--	ns
Q <sub>rr</sub>	Reverse Recovery Charge	di/dt=100A/μs	--	22	--	nC

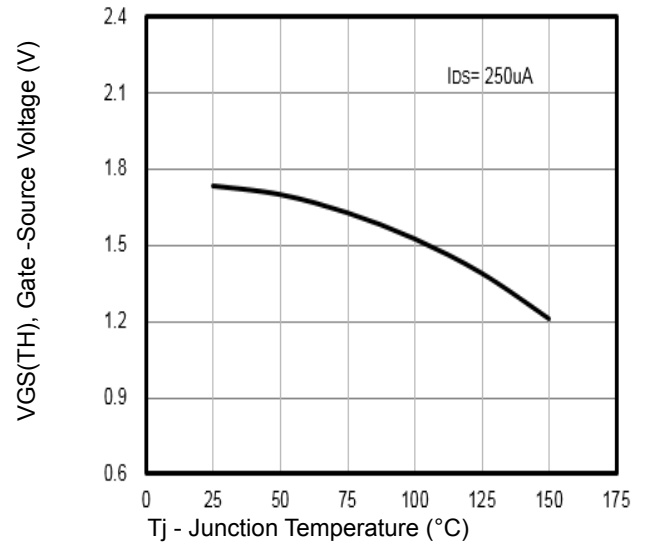
**NOTE:**

- ① Repetitive rating; pulse width limited by max junction temperature.
- ② Limited by T<sub>Jmax</sub>, starting T<sub>J</sub> = 25°C, L = 0.5mH, R<sub>G</sub> = 25Ω, I<sub>AS</sub> = 10A, V<sub>GS</sub> = 10V. Part not recommended for use above this value
- ③ Pulse width ≤ 380μs; duty cycle ≤ 2%.

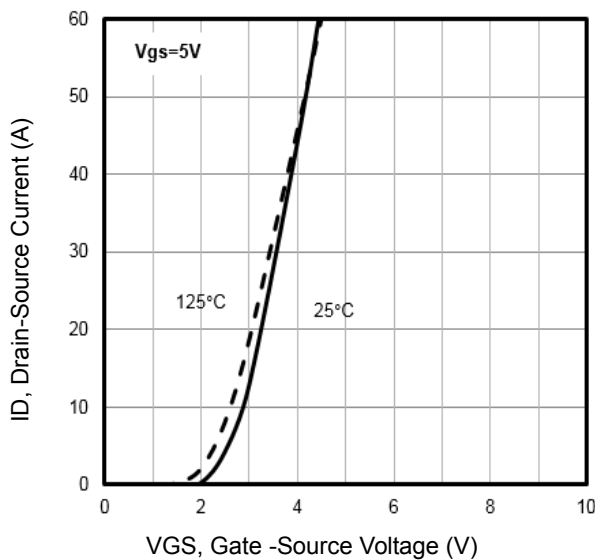
**Typical Characteristics**



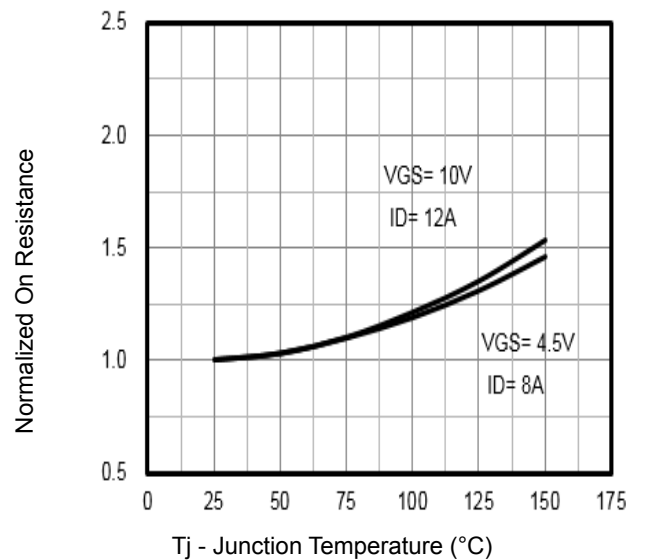
**Fig1.** Typical Output Characteristics



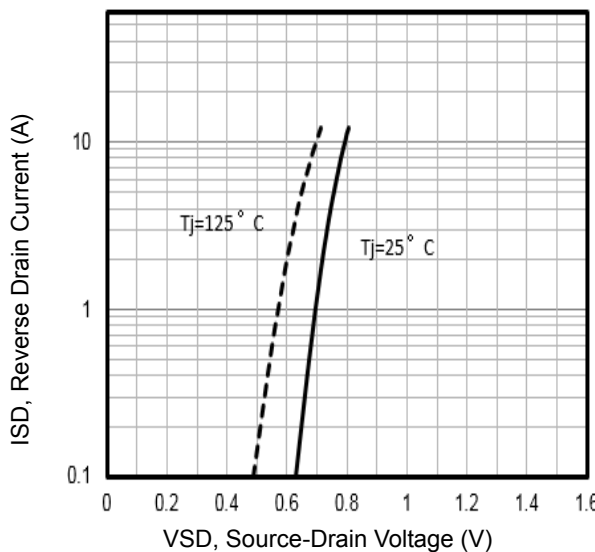
**Fig2.**  $V_{GS(TH)}$  Gate -Source Voltage Vs.  $T_j$



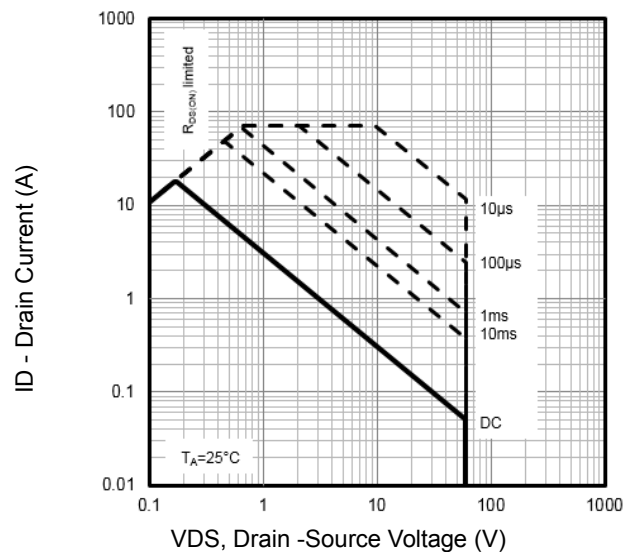
**Fig3.** Typical Transfer Characteristics



**Fig4.** Normalized On-Resistance Vs.  $T_j$



**Fig5.** Typical Source-Drain Diode Forward Voltage



**Fig6.** Maximum Safe Operating Area

Typical Characteristics

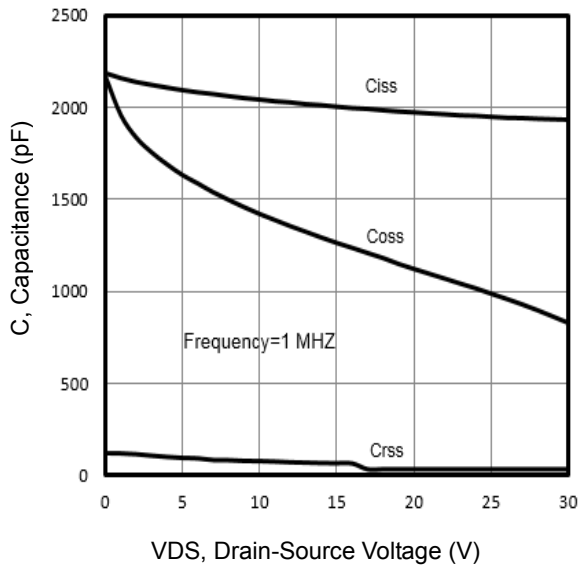


Fig7. Typical Capacitance Vs. Drain-Source Voltage

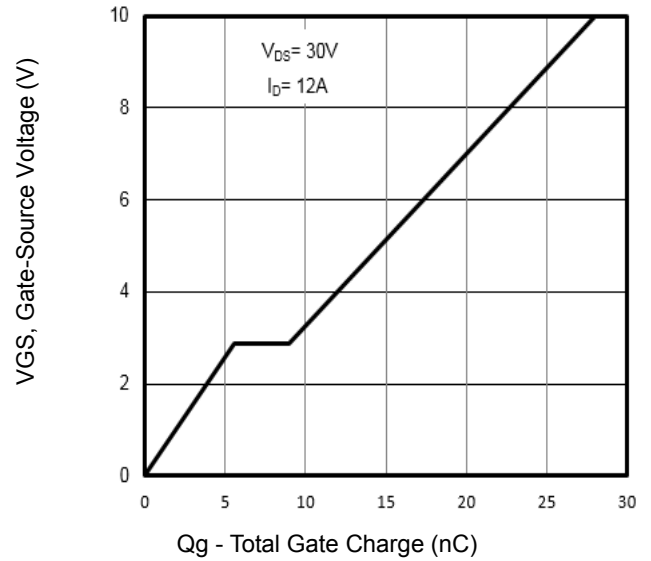


Fig8. Typical Gate Charge Vs. Gate-Source Voltage

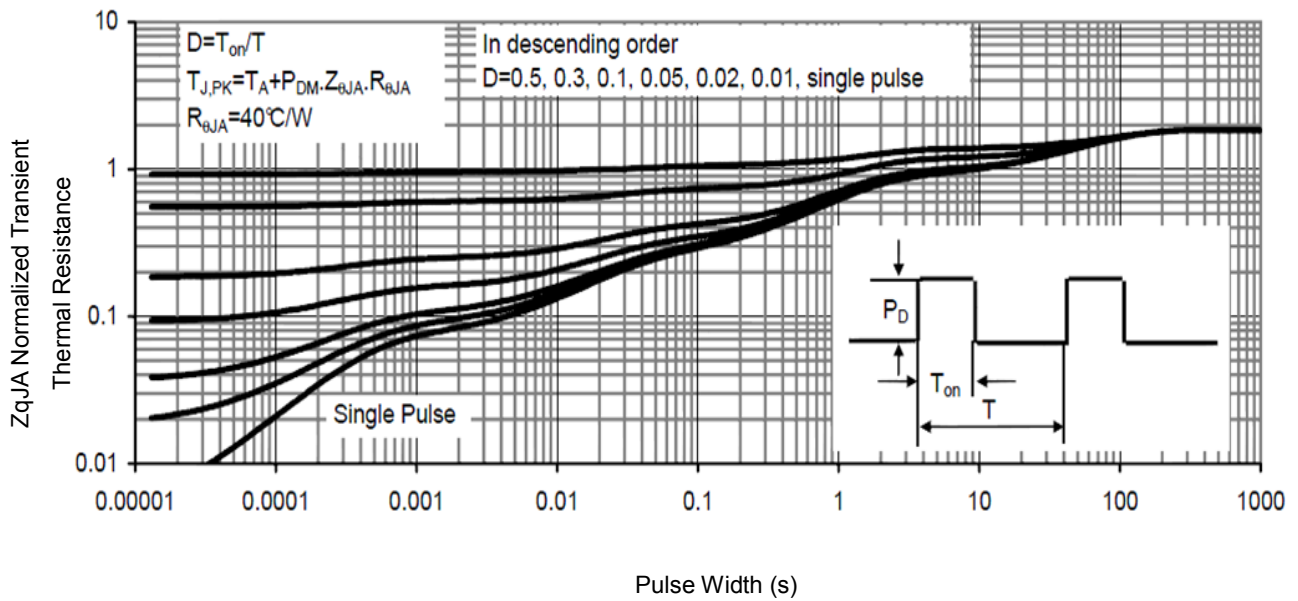


Fig9. Normalized Maximum Transient Thermal Impedance

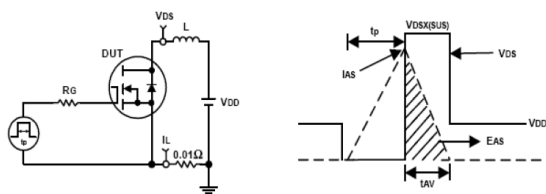


Fig10. Unclamped Inductive Test Circuit and waveforms

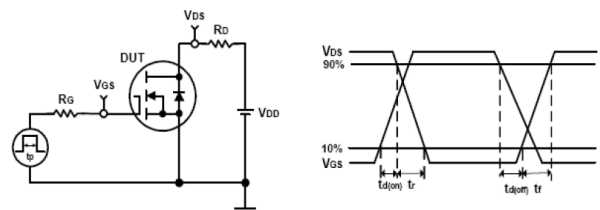
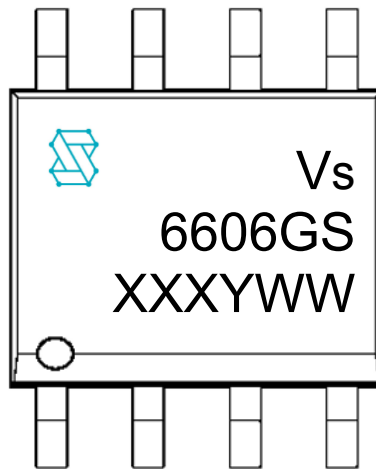


Fig11. Switching Time Test Circuit and waveforms

## Marking Information



1<sup>st</sup> line: Vanguard Code (Vs), Vanguard Logo

2<sup>nd</sup> line: Part Number (6606GS)

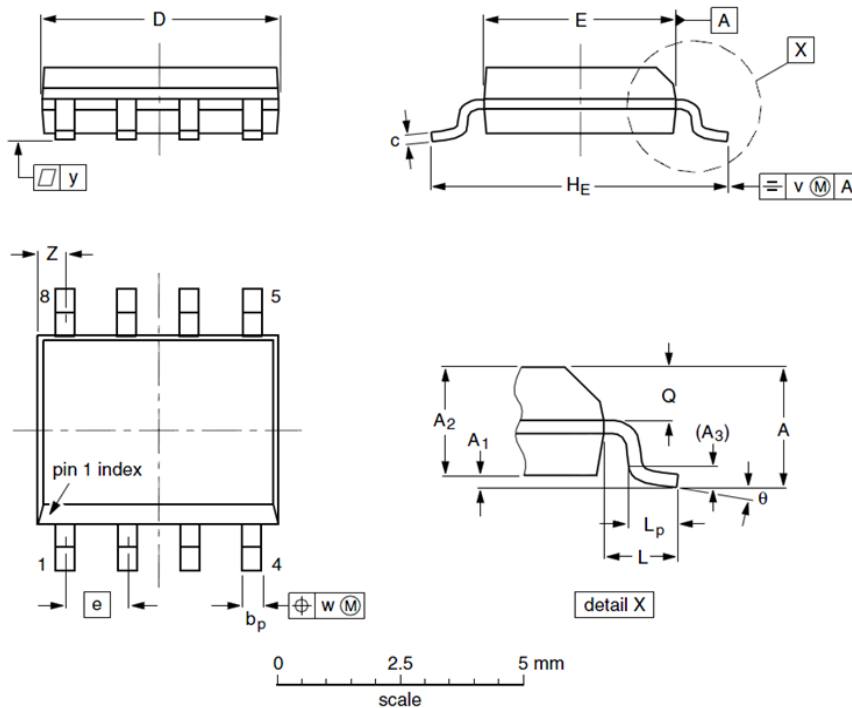
3<sup>rd</sup> line: Date code (XXXYWW)

XXX: Wafer Lot Number Code , code changed with Lot Number

Y: Year Code, (e.g. E=2017, F=2018, G=2019, H=2020, etc)

WW: Week Code (01 to 53)

SOP8 Package Outline Data



Label	Dimensions (unit: mm)		
	Min	Typ	Max
A	--	--	1.75
A <sub>1</sub>	0.10	0.18	0.25
A <sub>2</sub>	1.25	1.35	1.50
A <sub>3</sub>	--	0.25	--
b <sub>p</sub>	0.36	0.42	0.51
c	0.19	0.22	0.25
D	4.80	4.92	5.00
E	3.80	3.90	4.00
e	--	1.27	--
H <sub>E</sub>	5.80	6.00	6.20
L	--	1.05	--
L <sub>p</sub>	0.40	0.68	1.00
Q	0.60	0.65	0.725
v	--	0.25	--
w	--	0.25	--
y	--	0.10	--
Z	0.30	0.50	0.70
θ	0°		8°

Notes:

1. Follow JEDEC MS-012.
2. Dimension "D" does NOT include mold flash, protrusions or gate burrs. Mold flash, protrusions or gate burrs shall not exceed 0.15mm per side.
3. Dimension "E" does NOT include interlead flash or protrusion. Interlead flash or protrusion shall not exceed 0.25mm per side.
4. Dimension "b<sub>p</sub>" does NOT include dambar protrusion. Allowable dambar protrusion shall be 0.1mm total in excess of "b<sub>p</sub>" dimension at maximum material condition. The dambar cannot be located on the lower radius of the foot.

Customer Service

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